TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

# 2SK3417

#### Switching Regulator Applications

- Reverse-recovery time:  $t_{rr} = 60$  ns (typ.)
- Built-in high-speed flywheel diode
- Low drain-source ON resistance:  $RDS(ON) = 1.6 \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 4.0 \text{ S (typ.)}$
- Low leakage current:  $I_{DSS} = 100 \ \mu A (max) (V_{DS} = 500 \ V)$
- Enhancement-model:  $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

#### Maximum Ratings (Ta = 25°C)

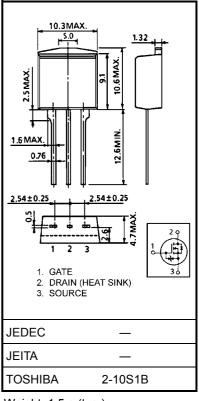
Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V <sub>DSS</sub>	500	V	
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		V <sub>DGR</sub>	500	V	
Gate-source voltage		V <sub>GSS</sub>	±30	V	
Drain current	DC (Note 1)	I <sub>D</sub>	5	А	
	Pulse (Note 1)	I <sub>DP</sub>	20	~	
Drain power dissipat	ion (Tc = 25°C)	PD	50	W	
Single pulse avalanche energy (Note 2)		E <sub>AR</sub>	180	mJ	
Avalanche current		I <sub>AR</sub>	5	А	
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	5	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

## **Thermal Characteristics**

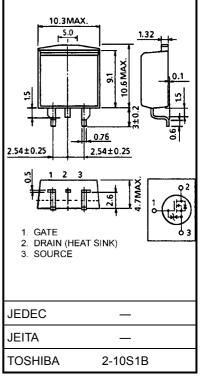
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	2.5	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	83.3	°C/W

- Note 1: Please use devise on condition that the channel temperature is below 150°C.
- Note 2: V\_{DD} = 90 V, T\_{ch} = 25 ^{\circ}C (initial), L = 12.2 mH, R\_G = 25  $\Omega,$  I\_{AR} = 5 A
- Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.



Weight: 1.5 g (typ.)



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Unit: mm

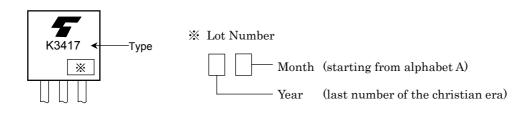
**Electrical Characteristics (Ta = 25°C)** 

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I <sub>GSS</sub>	$V_{GS}=\pm 25~V,~V_{DS}=0~V$	_		±10	μA
Drain-source bre	akdown voltage	V (BR) GSS	$I_G=\pm 100~\mu\text{A},~V_{DS}=0~\text{V}$	±30			V
Drain cut-OFF cu	ırrent	I <sub>DSS</sub>	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_		100	μA
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500			V
Gate threshold ve	oltage	V <sub>th</sub>	$V_{DS} = 10 V, I_D = 1 mA$	2.0		4.0	V
Drain-source ON	resistance	R <sub>DS (ON)</sub>	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	_	1.6	1.8	Ω
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	2.5	4.0		S
Input capacitance		C <sub>iss</sub>			780		pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	_	60		
Output capacitance		C <sub>oss</sub>			200		
Switching time	Rise time	tr	$V_{GS}^{10 V} \downarrow I_D = 2.5 \text{ A } V_{OUT}$ $0 V \downarrow I_D = 2.5 \text{ A } V_{OUT}$ $R_L = 90 \Omega$ $V_{DD} \simeq 225 V$ $Duty \le 1\%, t_W = 10 \mu s$	_	12	_	
	Turn-ON time	t <sub>on</sub>			25		
	Fall time	t <sub>f</sub>			15		ns
	Turn-OFF time	t <sub>off</sub>		_	60	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		17	_	nC
Gate-source charge		Q <sub>gs</sub>			11		
Gate-drain ("miller") charge		Q <sub>gd</sub>			6		

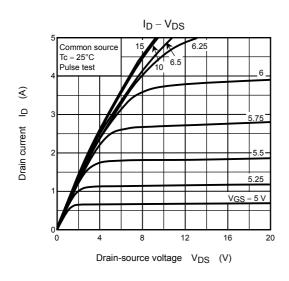
# Source-Drain Ratings and Characteristics (Ta = 25°C)

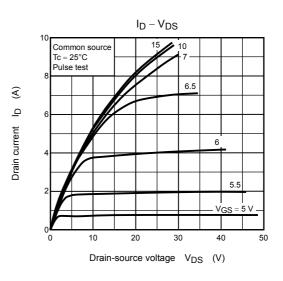
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—			5	А
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_		20	А
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 5 A, V <sub>GS</sub> = 0 V	_		-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 5 A, V <sub>GS</sub> = 0 V,		60		ns
Reverse recovery charge	Q <sub>rr</sub>	dI <sub>DR</sub> /dt = 100 A/µs	_	0.1	_	μC

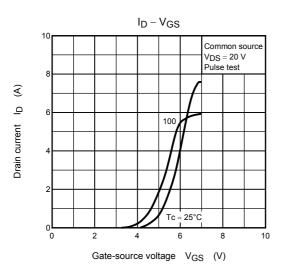
# Marking

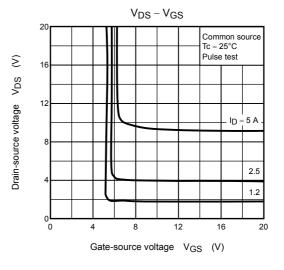


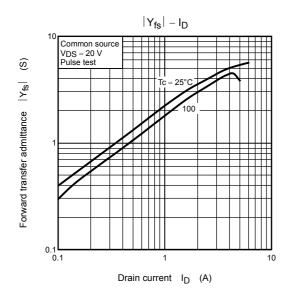
# **TOSHIBA**



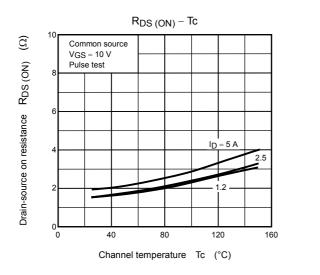


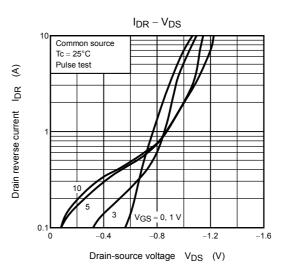


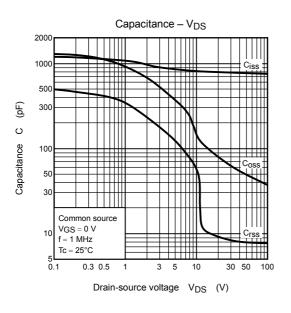


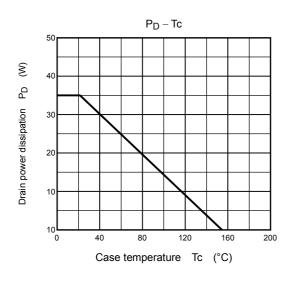


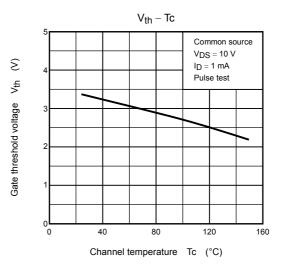
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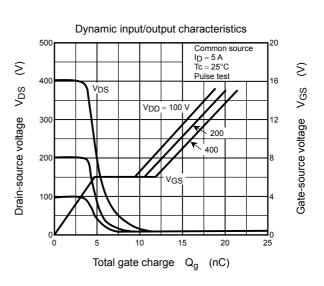


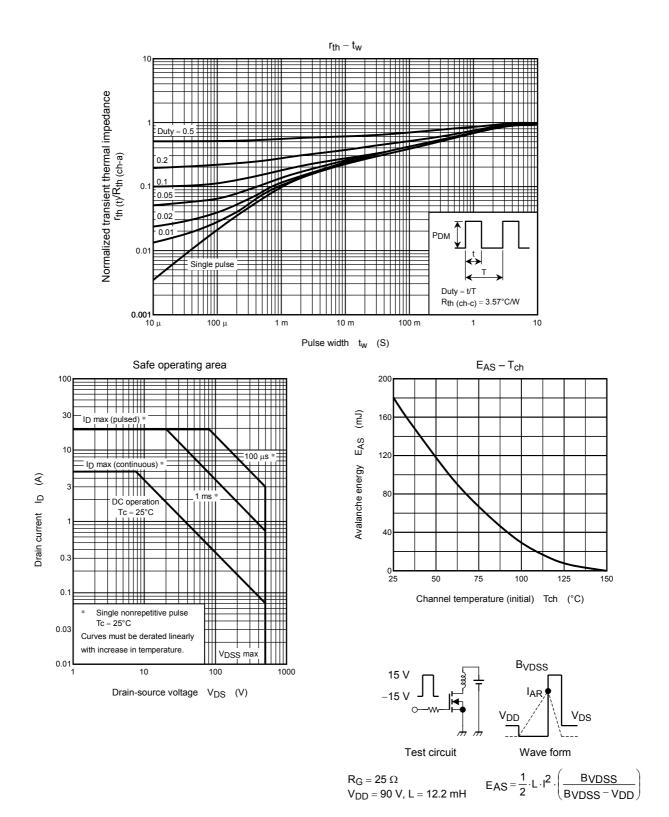












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